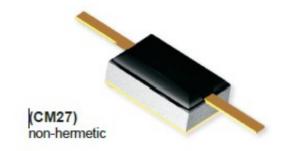


Pin Diode Switch Element

Rev. V1

Features

- High Power Handling: 80 W @ 2 GHz or Less
- Low Insertion Loss:
 - <0.35 dB @ 2 GHz
 - <0.60 dB @ 6 GHz
- Medium Isolation:
 - >22 dB @ 2 GHz
 - >14 dB @ 6 GHz
- RoHS* Compliant



Description

The MEST2G-080-25-CM27 is a thermal to ground series diode switch element in a Alumina Nitride package. This part is designed for reliable high power switch application up to 80 watts. Usable up to 10 GHz.

Electrical Specifications: $T_c = +25^{\circ}C$ (unless otherwise specified)

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Breakdown Voltage (V _{BR})	I _R = 10 mA, single diode	V	500	_	_
Leakage Current (I _R)	I _F = 100 V, single diode	nA	_	40	100
Forward Voltage (V _F)	I _F = 100 mA, single diode	mV	_	0.93	1.05
Series Resistance (R _S)	I _F = 100 mA, single diode	Ω	_	0.97	_
Junction Capacitance (C _J)	V _R = 50 V, 1 MHz, single diode	pF	_	0.09	
Lifetime (t)	I _F = 10 mA, I _R = 6 mA, @ 50%	ns	_	1550	_
I-Region (w)	I-Layer, single diode	μm	_	80	_
Return Loss (R _L)	I _F = 100 mA, 2 GHz I _F = 100 mA, 6 GHz	dB	27 13	31 16	_
Insertion Loss (I _L)	I _F = 100 mA, 2 GHz I _F = 100 mA, 6 GHz	dB	_	0.20 0.45	0.35 0.60
Isolation (I _{SO})	V _R = 10 V, 2 GHz V _R = 10 V, 6 GHz	dB	22 14	25 17	_

^{*} Restrictions on Hazardous Substances, European Union Directive 2011/65/EU.



Pin Diode Switch Element

Rev. V1

Absolute Maximum Ratings^{1,2}

Parameter	Absolute Maximum		
Breakdown Voltage (V _R)	500 V		
Forward Current (I _F)	200 mA		
Theta (θ _{JC})	10°C/W		
Junction Temperature (T _J)	-40°C to +175°C		
Storage Temperature (T _{STG})	-55°C to +150°C		
Mounting Temperature (T _{MTG})	+260°C per JEDEC STD-J-20C		

- 1. Exceeding any one or combination of these limits may cause permanent damage to this device.
- MACOM does not recommend sustained operation near these survivability limits.

Handling Procedures

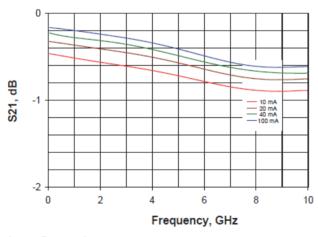
Please observe the following precautions to avoid damage:

Static Sensitivity

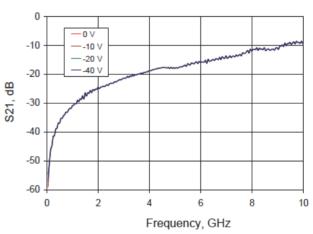
These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these Class 0 (HBM) devices.

Typical Performance Curves: T_A = 25°C, -10 dBm Small Signal

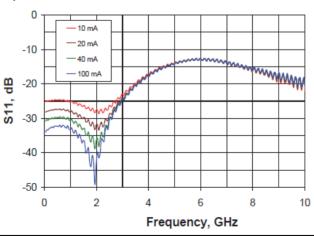
Insertion Loss



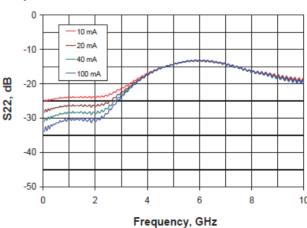
Isolation



Input Return Loss



Output Return Loss



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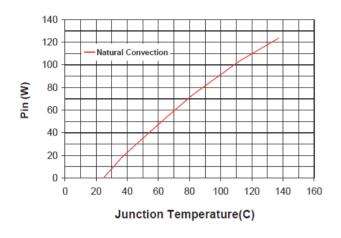
2



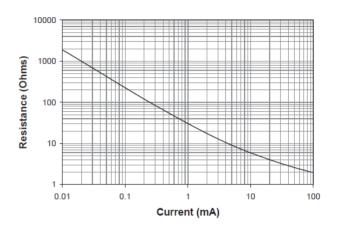
Pin Diode Switch Element

Rev. V1

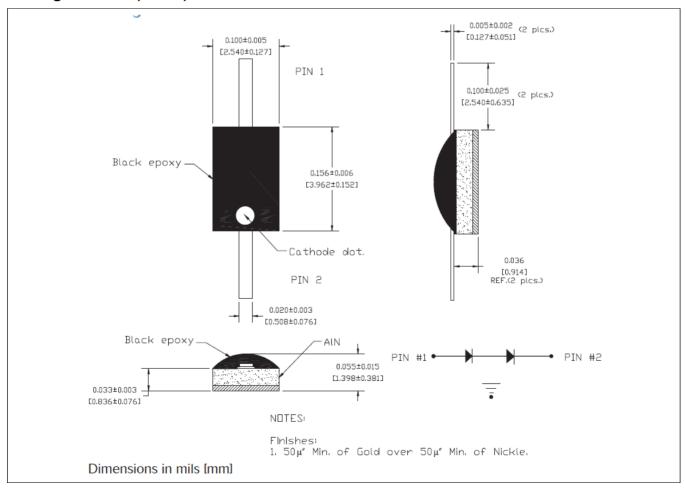
Junction Temperature vs. PIN (Mounted on Heat Sink @ T_A = +25°C, 1.3 GHz)



Resistance vs. Current, 500 MHz For Two Diodes in Series



Package Outline (CM27)



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MEST2G-080-25



Pin Diode Switch Element

Rev. V1

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